

Addendum 1 dated 02.05.2018

1.	RFP No	RFP NO: SYS: 2018/06
2.	Brief Description of the RFP	Tender for supply/installation/integration/maintenance of Hardware Security Modules (HSM)
3.	Last Date for Submission of Bids / Offers	02nd May 2018 at 15:00 Hrs
4.	Date & Venue of Pre - Bid Meeting	04th May 2018 at 11:00 Hrs Venue: BOB Financial Solutions Limited, 2 nd Floor, Baroda House, Behind Dewan Shopping Centre, S V Road, Jogeshwari (West) Mumbai – 400 102

S/d
Authorized Signatory
Date: 02nd May 2018